

# EEE 163

# System Design Analysis

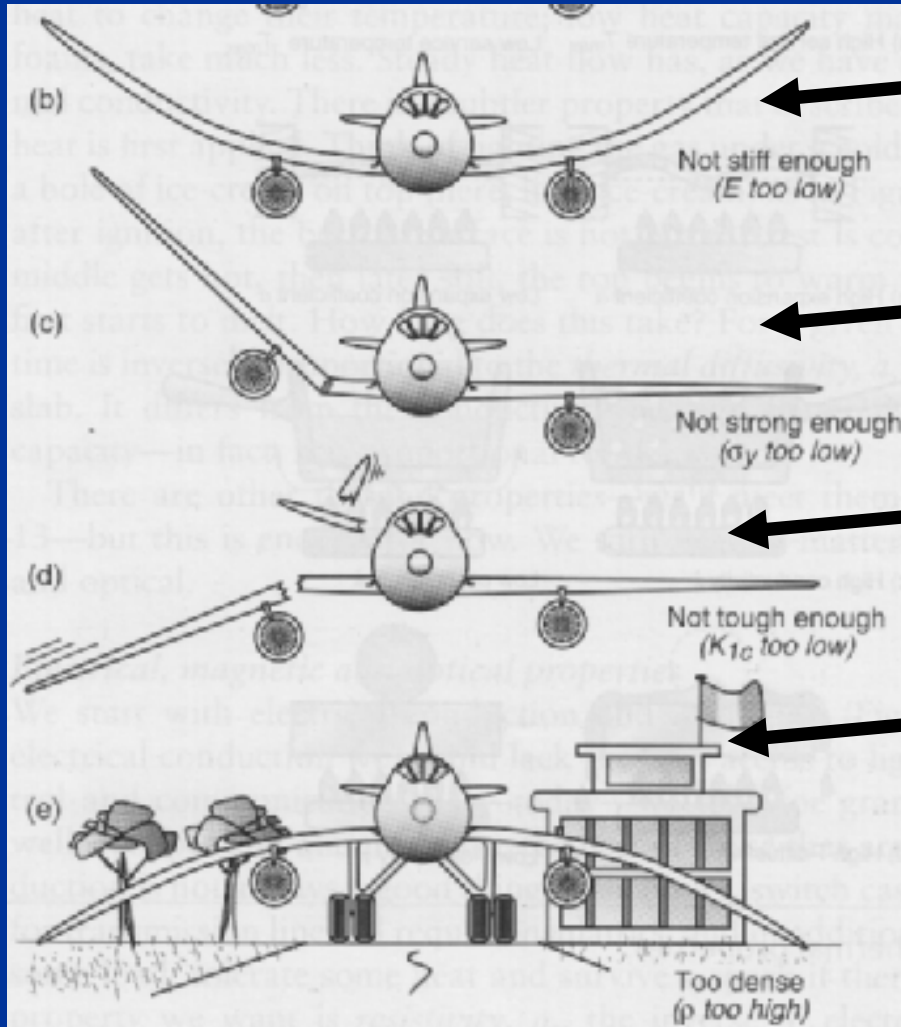
## Lecture 2 – Engineering Materials

Dr Gavin Williams  
Room F167, Mappin Building  
[g.williams@sheffield.ac.uk](mailto:g.williams@sheffield.ac.uk)

# Engineering Materials

- Useful properties
- Material families
- Property comparisons
- Manufacturing methods

# Material Properties – Mechanical



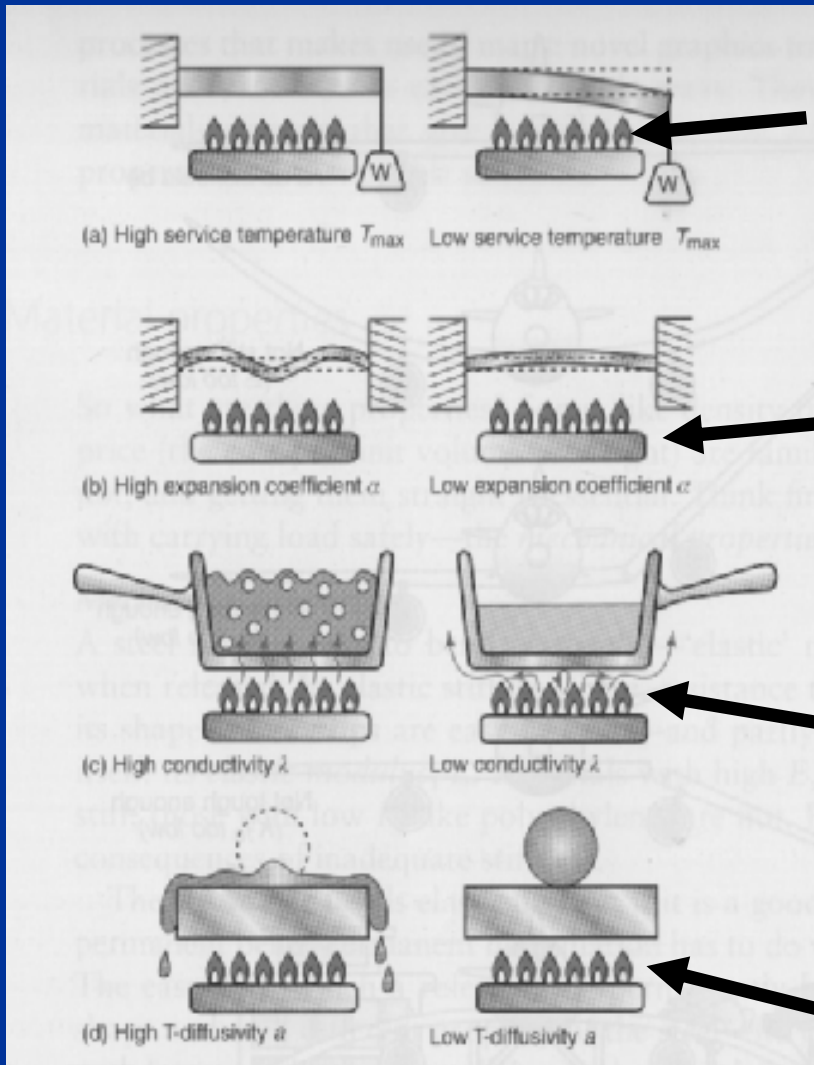
Elasticity

Strength

Fracture toughness

Density

# Materials Properties - Thermal



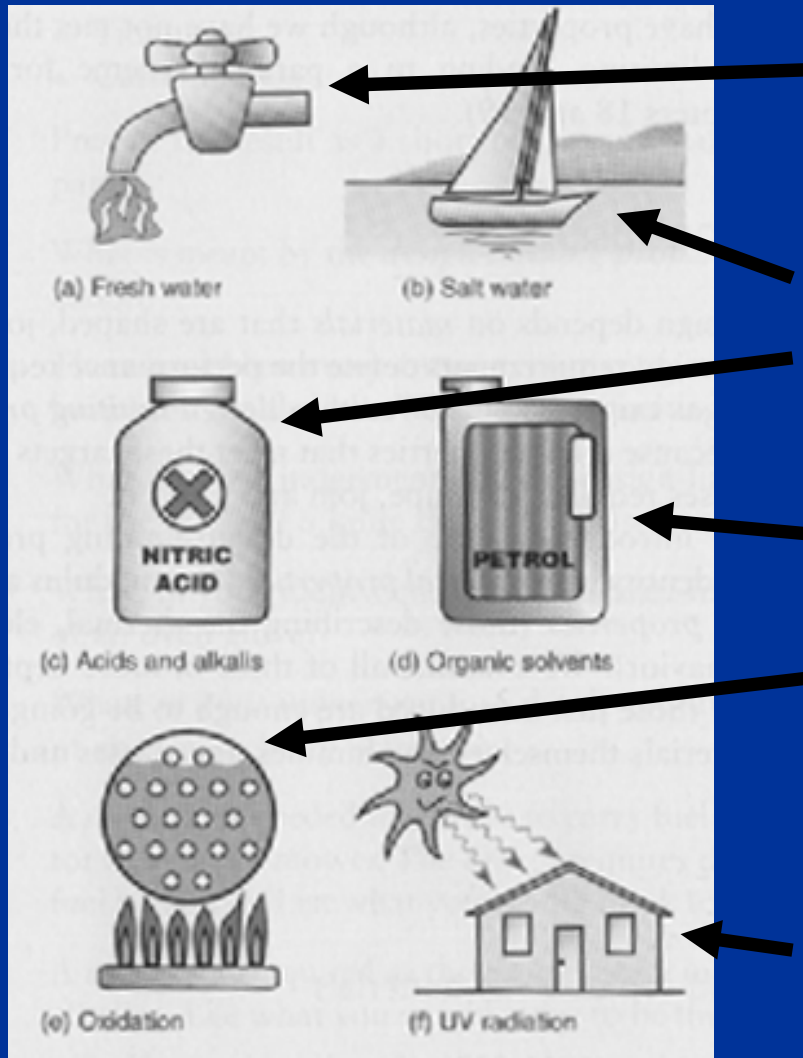
Max. operating temperature  
 $T_{max}$  ( $^{\circ}\text{C}$ )

Thermal expansion  
coefficient  $\alpha$  ( $\text{ppm}/^{\circ}\text{C}$ )

Thermal conductivity  $k_{th}$   
( $\text{W}/\text{m}^{\circ}\text{C}$ )

Heat capacity  $C_p$  ( $\text{J}/\text{kg}^{\circ}\text{C}$ )

# Materials Properties - Chemical



Fresh water

Salt water

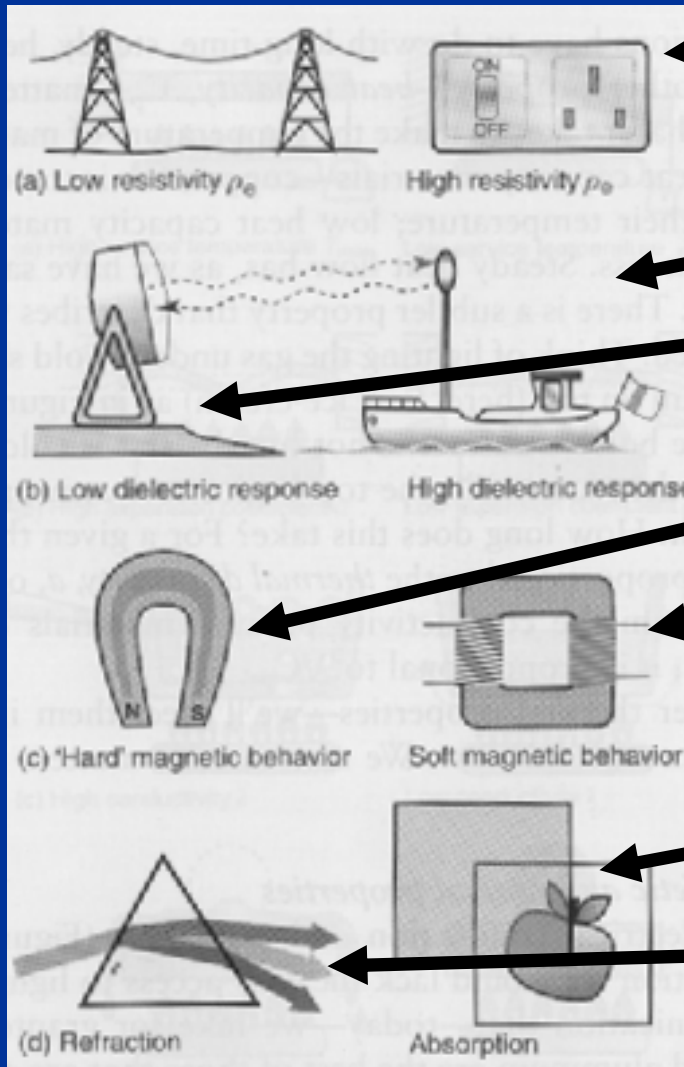
Acids and alkalis

Organic solvents

Atmospheric  
oxidation/tarnishing

Ultra-violet radiation

# Materials Properties - Electromagnetic



Electrical resistance  $R$  ( $\Omega$ )

Dielectric response ( $\epsilon_D$ )

Magnetic -

'Hard' (permanent magnet)

'Soft'

Optical:

Absorption

Dispersion

# Engineering Materials Families

## Metal

gold, copper, alloys (steel, solder)

## Ceramic

Porcelain, alumina

## Polymer

plastic bags, rubber bands

## Vitreous (glass)

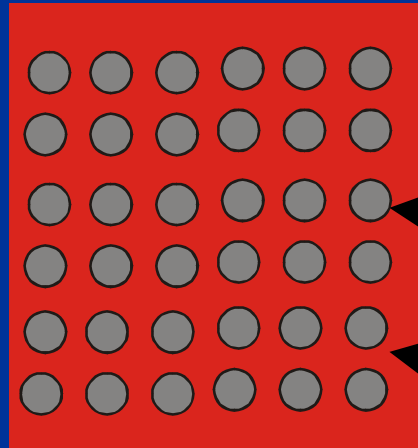
windows, optical fibres

## Hybrid (i.e. items from different families)

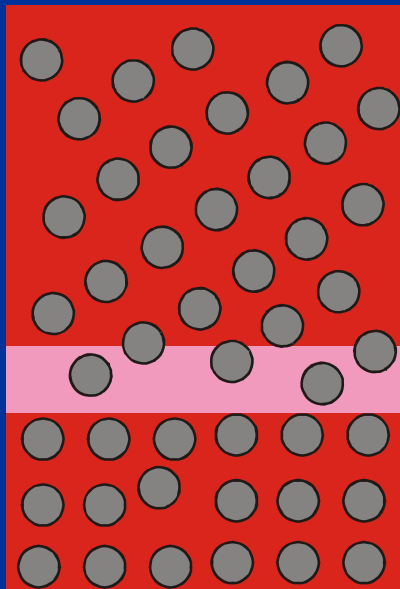
Natural structural materials e.g. bone = polymer + ceramic  
fibre-glass, foam

**N.B.** Not salts – generally too soluble

# Metal - Structure



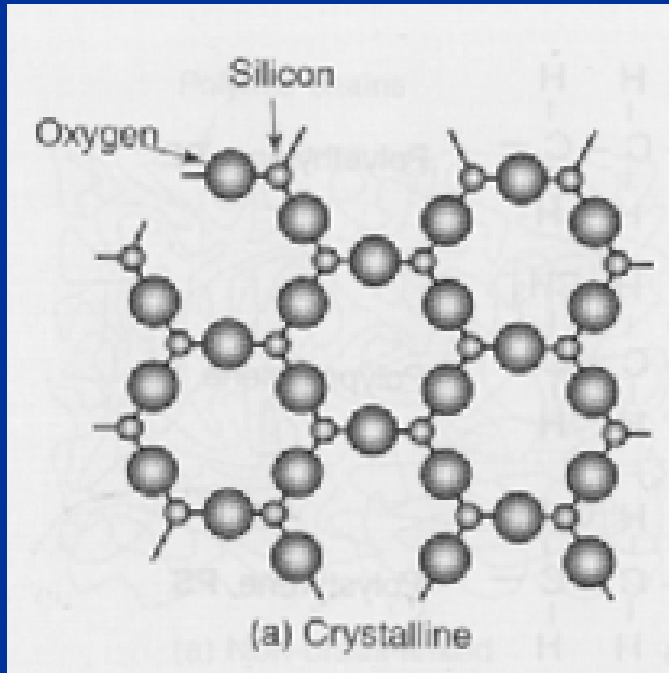
- Single crystal
  - atomic nuclei in regular periodic lattice
  - electrons delocalised



- Polycrystalline
  - grain boundaries
  - non-uniform electron density

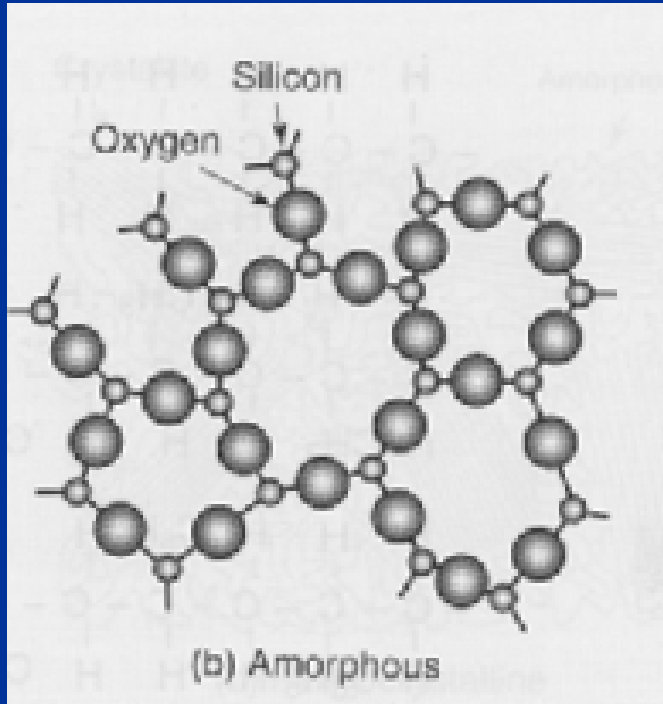


# Ceramic - Structure



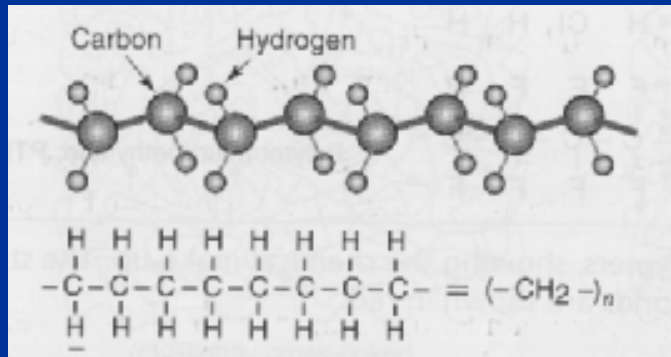
- Regular 3d crystal lattice with strong inter-atomic bonds:
  - Covalent (electron sharing)
- Oxide, nitride, carbide, etc...
- Single crystal
  - e.g. gemstone – rare!
- Polycrystalline
  - e.g. rock – common!
  - many grain boundaries

# Glass - Structure

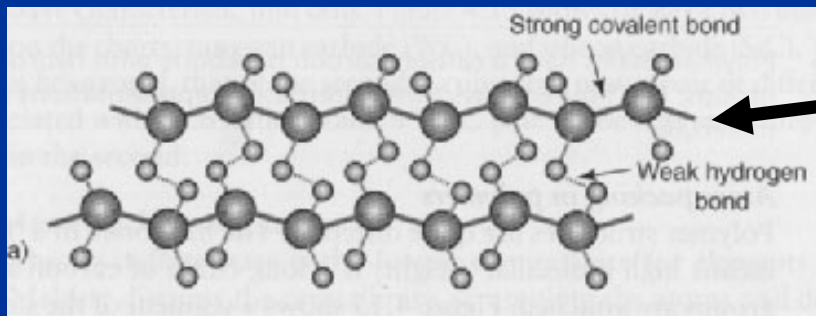


- Non-regular 3d lattice
- Covalent bonds, since these allow bond angle distortion
- *Not* ionic bonds, since these don't allow bond angle distortion
- 'Infinite' single crystal
  - no grain boundaries
  - good optical properties

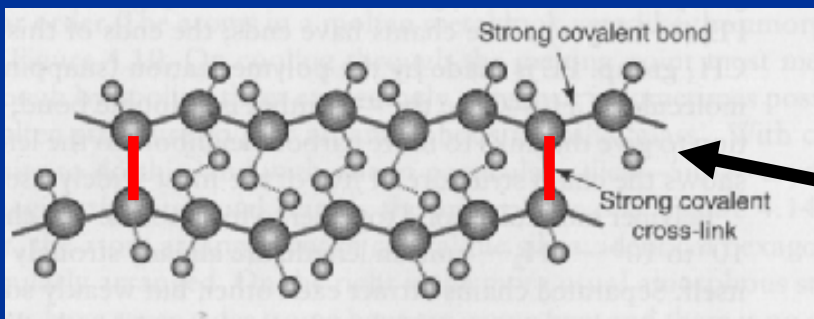
# Polymer - Structure



Long chain molecule with carbon backbone

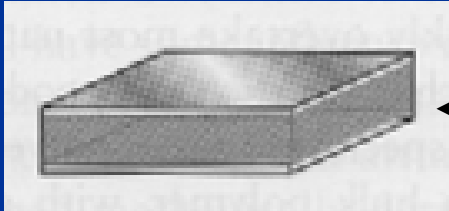


Thermoplastic – only weak hydrogen bonds between the chains



Thermoset – strong covalent bond between the chains

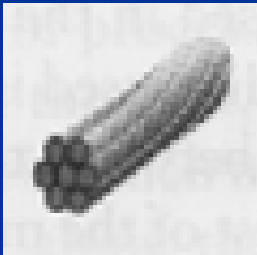
# Hybrid - Structure



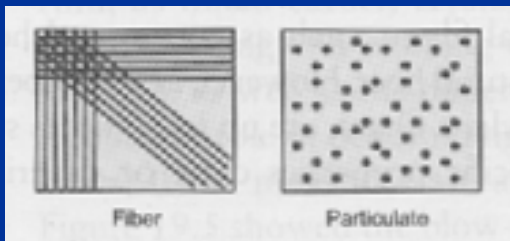
- Layers



- Lattice

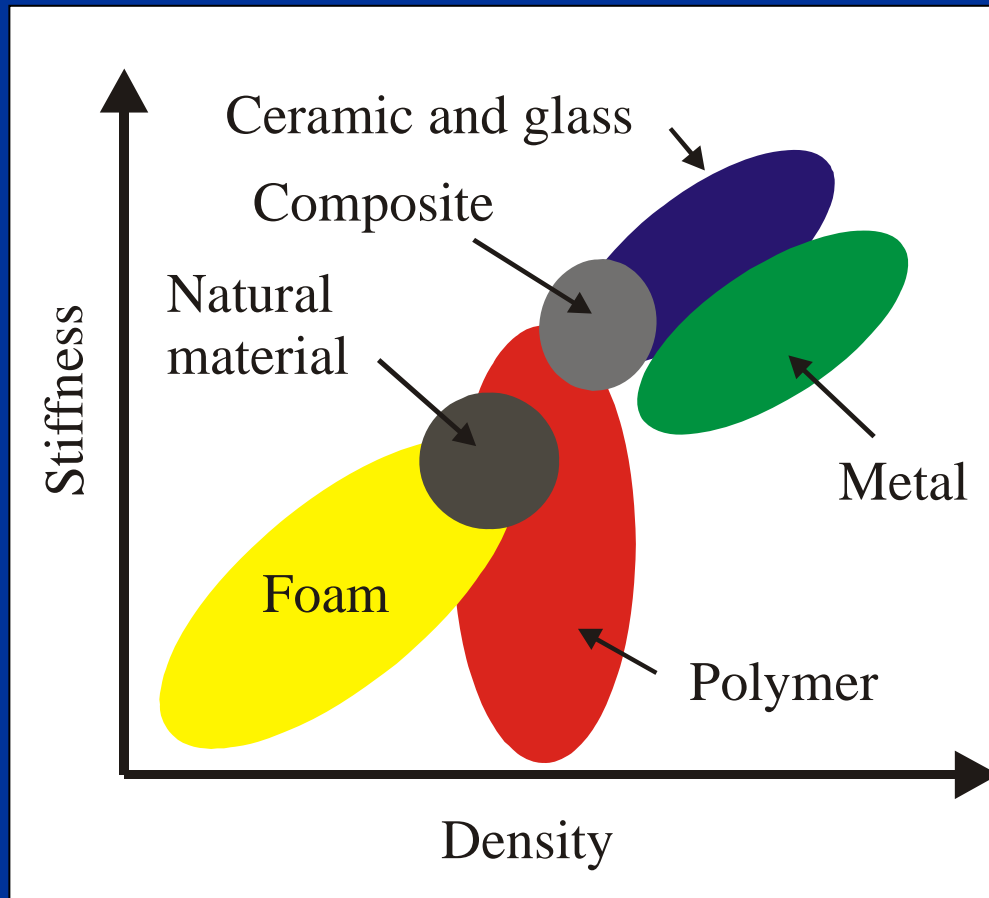


- Segmented



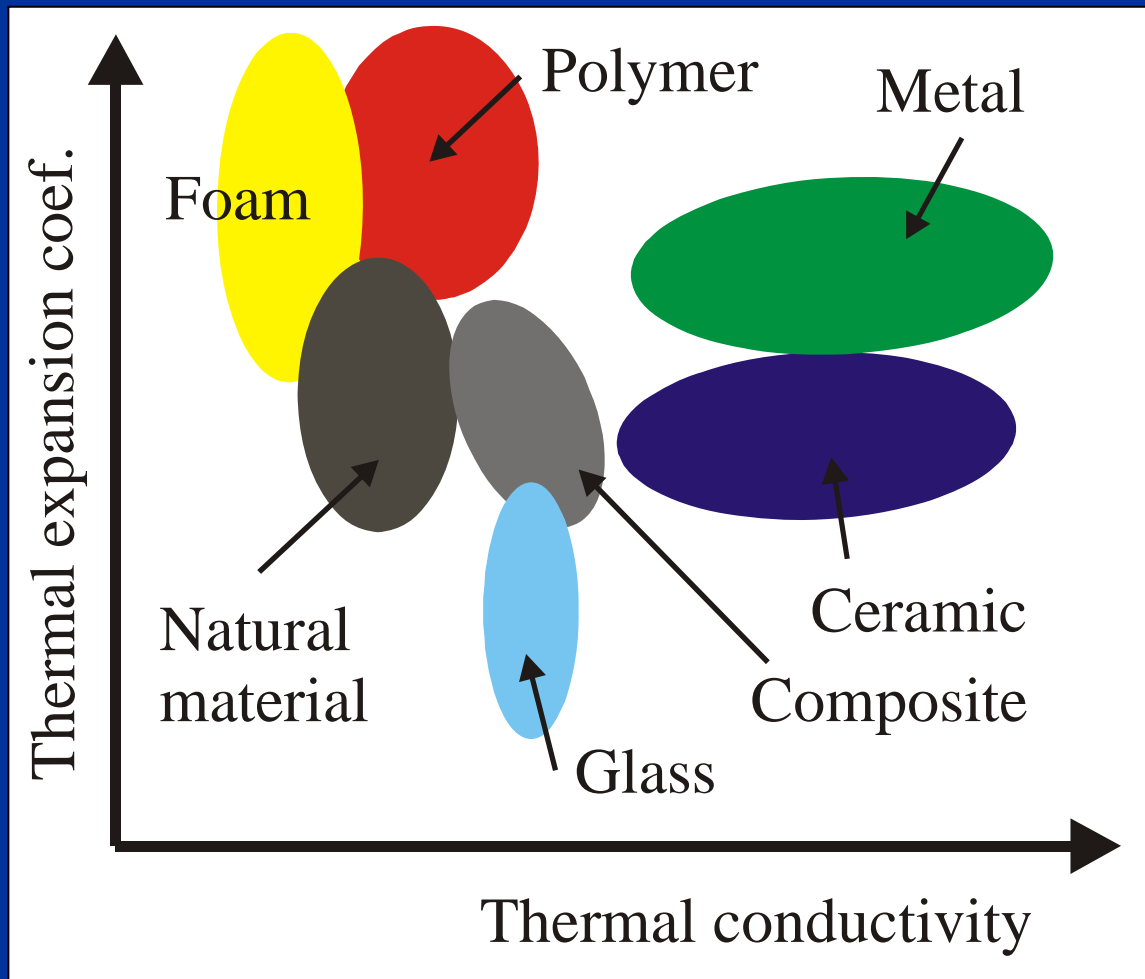
- Composite

# Property comparison 1: Weight v. stiffness

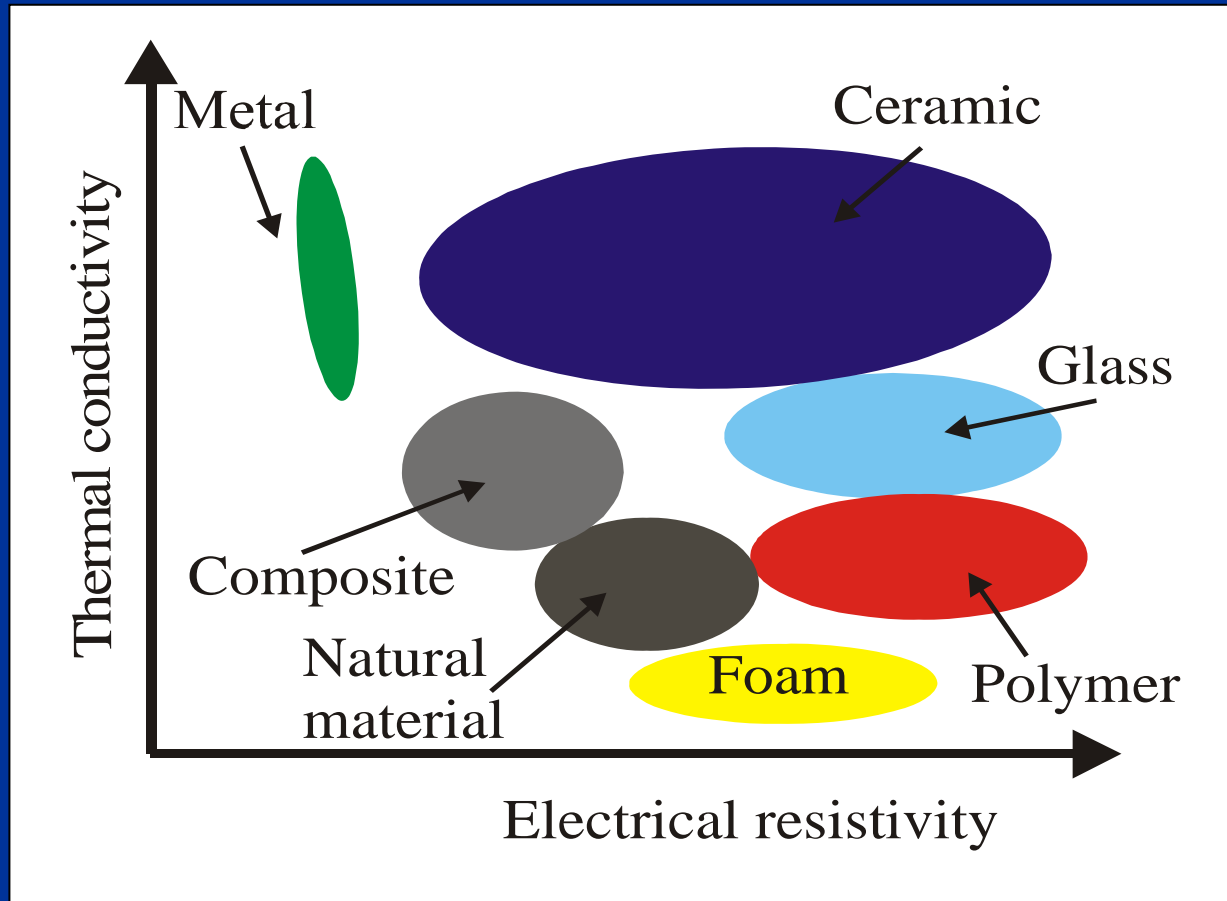


\*N.B. Logarithmic scales!\*

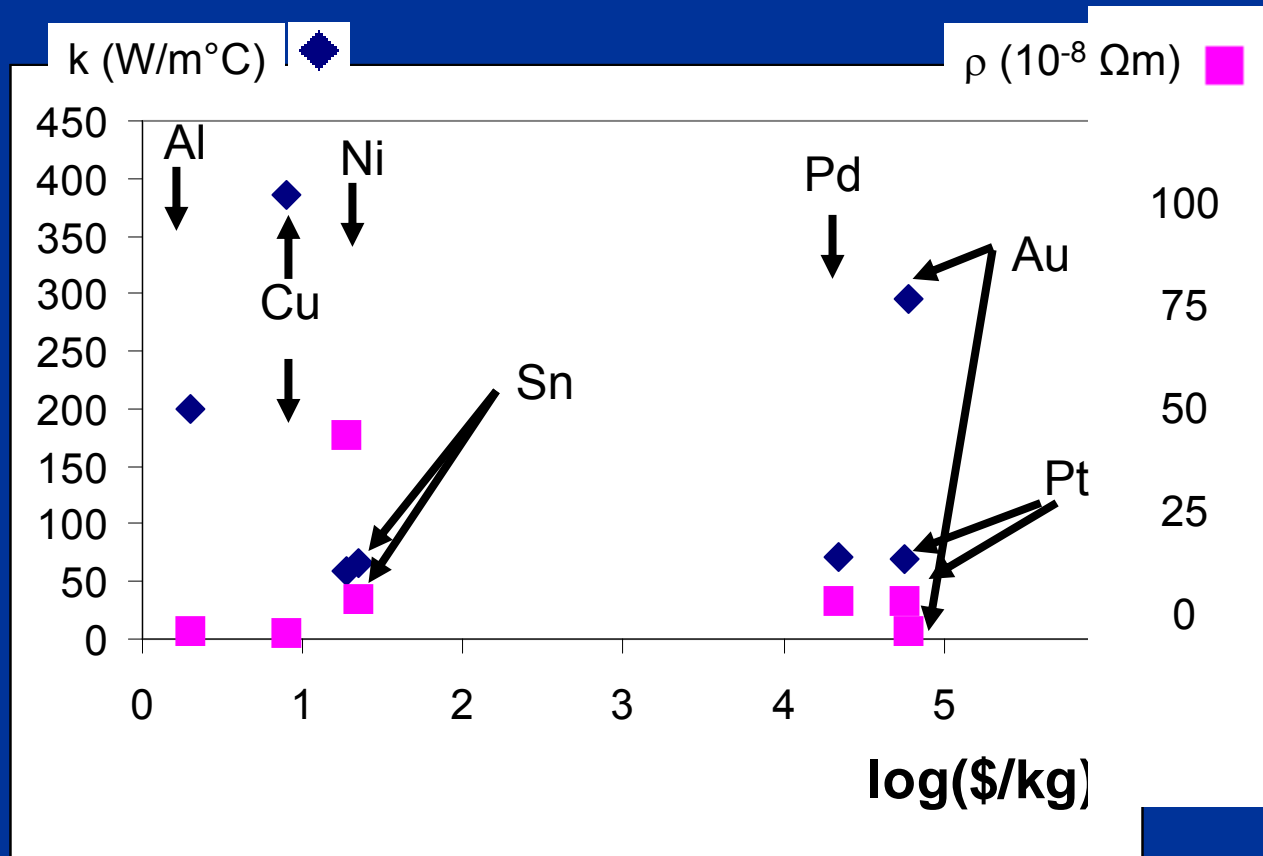
# Property comparison 2: Thermal conductivity v. expansion



# Property comparison 3: Resistivity v. thermal conductivity



# Property comparison 4: Metal prices v. conductivity and resistivity

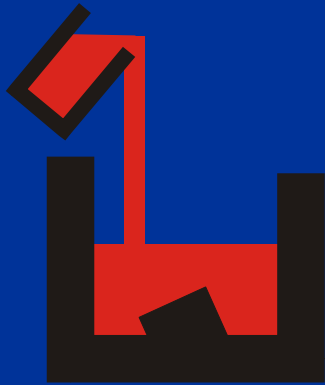


$10^4$  difference in price between metals!

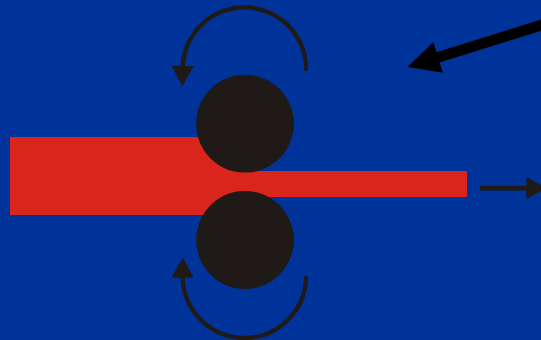
The cheaper metals will all tarnish (oxidise) in air, hence poor



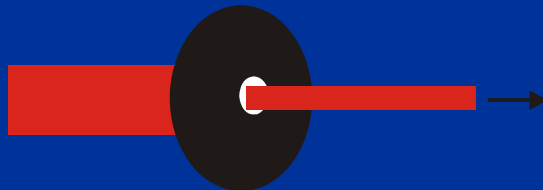
# Metal shaping



- Casting
  - Molten metal
  - Complex shapes

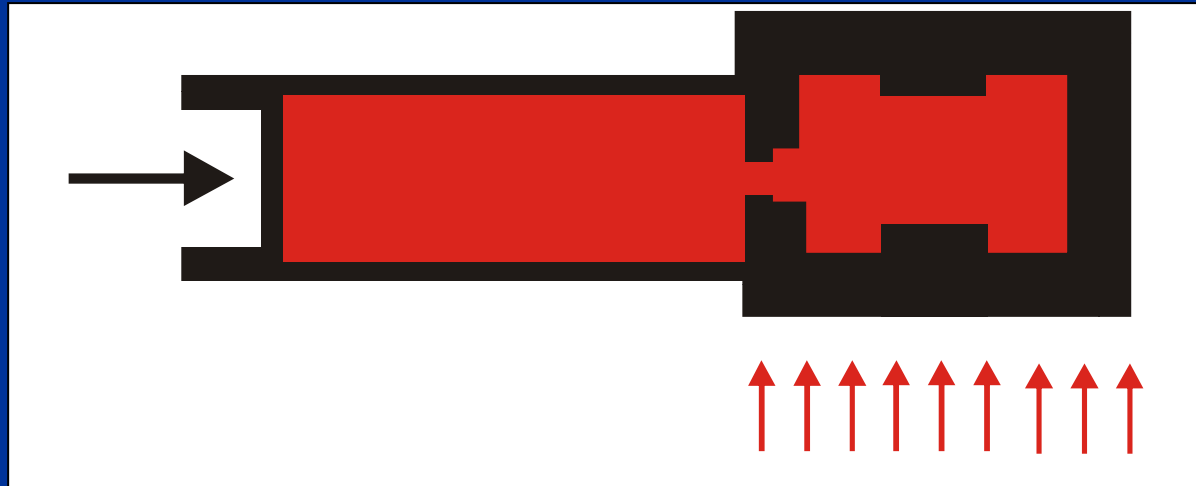


- Rolling mill
  - Solid sheet
  - Followed by bending, stamping



- Extrusion
  - Wire
  - Uniform cross-section rod

# Polymer shaping



## Injection moulding

- thermoplastic:

  - liquid or granular precursor

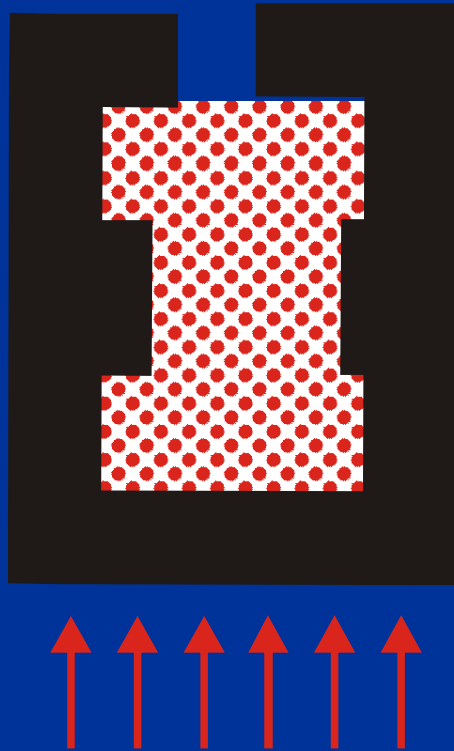
  - heat applied to melt material

- thermoset

  - liquid precursor

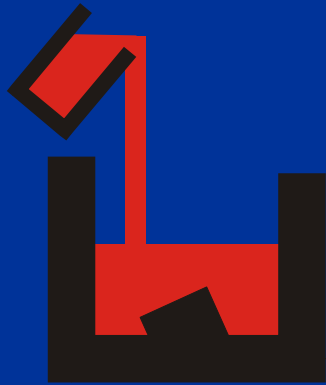
  - heat applied to initiate polymerisation and cross-linking

# Ceramic shaping

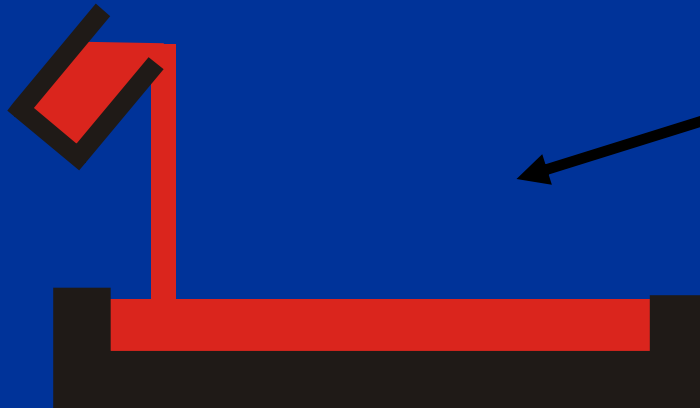


- Very high melting point ( $T_m$ )
- Sintering
  - Load mould with ceramic powder
  - Apply heat (and pressure)
  - Diffusion of atoms between grains at  $T < T_m$
  - grains fused together to form single object

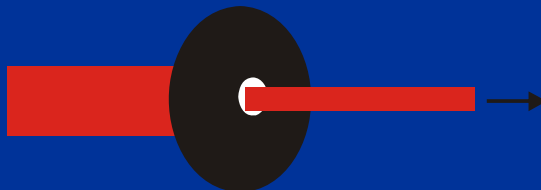
# Glass Shaping



- Moulding
  - complex shapes



- Casting
  - sheets



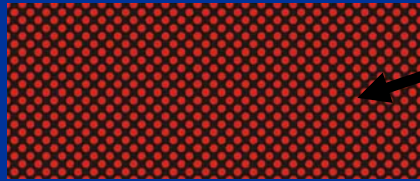
- Drawing
  - fibres



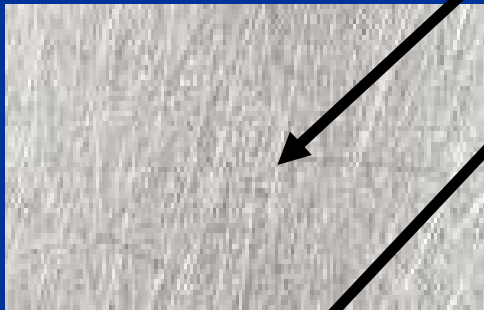
# Hybrid Shaping



← **Lamination** – e.g. printed circuit board



← **Impregnation** – e.g. silica-loaded epoxy

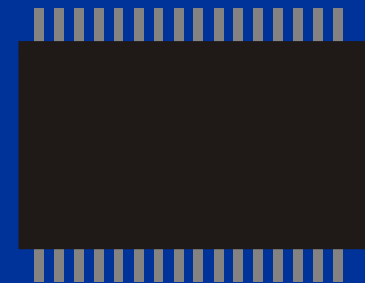
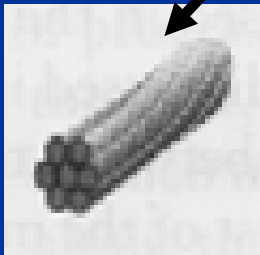


**Weaving** – e.g. fibre glass

**Platting** – e.g. cable

**2-part moulding** – e.g. IC package

**Etc...**



# Materials Joining

- Adhesive
  - organic polymer
  - low service temperature
  - non-hermitic
- Welding
  - metal or alloy (solder)
  - hermitic
- Mechanical fasteners
  - nuts and bolts
  - crimps

# Surface finishing

- Mold surface finish may be ok, but if not:
  - Precision machining
  - Grinding and polishing
  - Painting
  - Marking

# Lecture 2 Summary

- Engineering materials have many different properties
- Choosing which material to use in a product will always involve compromise
- You will explore the use of these various materials in the laboratory classes

## References:

eBook: 'Materials – Engineering, Science, Processing and Design' Ashby, Shercliff and Cebon, Elsevier.

Website: [www.webelements.com](http://www.webelements.com)